Product Change Notification

The information below reflects a change that is being implemented.

Notice Date:

03/28/2007

Product Category:

Linear Devices; Mixed Signal Devices; Power Management; Supervisor; Serial Communication

Notification Subject:

CCB#729: Qualification of 16L SOIC Wide Body (.300") Package at UNIS, Malaysia.

Notification Body:

Microchip Part#s Affected: MCP6S28 TC1021 TC1027 MCP3008 MCP3208 MCP3304 MCP3907 MCP3908 **TC500 TC500A TC520A MCP1403** MCP1404 MCP1405 TC170 TC4423 TC4423A TC4424 TC4424A TC4425 TC4425A TC4467 TC4468 TC4469 TC4626 TC4627 TC962 TC1232 TC232

Description of Change:

ALTERNATIVE ASSEMBLY SITE FOR 16L SOIC WIDE BODY (.300") PACKAGE

Impacts to Data Sheet: NONE

Reason for Change: TO INCREASE MANUFACTURING CAPACITY

Estimated Change Implementation Date(s): MAY 31, 2007

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking) COO; TRACEABILITY CODE